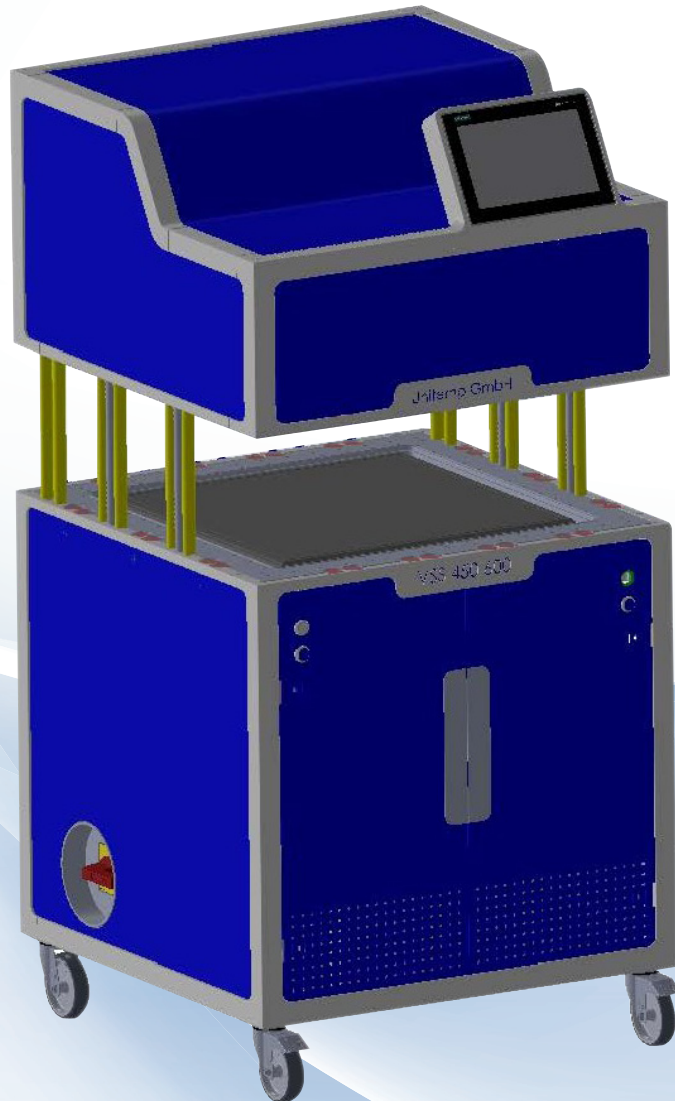


Vacuum Soldering System for big size substrates



VSS-650 Vacuum Solder System

VSS-620, VSS-620-HV

- For substrate size up to 620 mm x 620 mm
- Ramp up rate up to xxx K/min, ramp down rate up to xxx K/min
- SIMATIC® Controller with 12" touch panel
- Vacuum up to 10^{-3} hPa (opt. 10^{-6} hPa)
- Process gas line with Mass Flow Controller for Nitrogen
- Temperature up to 450 °C

Application

Reflow Solder Processes with or without vacuum up to 10^{-6} hPa. Easy profiling by using a SPS SIMATIC® Controller with WIN based software. Perfect lab tool and also for production on a low cost base. High production output. A remote control can be adjusted and the system can easily integrated into a production line.

- Reflow Solder Processes with flux
- Operation with inert gas, Oxygen, Forming gas, Formic Acid
- Lead and Lead-free SMT reflow
- Resistor paste firing

Features

- Precise ramp up and fast ramp down rates
- Up to 4 gas lines (Mass Flow Controller)
- Heated by Infrared lamps
- 50 programs with 50 steps each
- Bottom heating
- Small foot print
- 3 heating zones programmable

VSS-620, VSS-620-HV

- Vacuum Solder System
- Programmable temperature profiles
- Record of process data
- Process in different gas atmospheres

The VSS-620 Vacuum Process Oven

The VSS-620 Reflow Solder System is an excellent tool for various solder processes up to 620 x 620 mm substrate size and 75 mm height (higher on request).

Some examples for applications:

Laboratory furnace for all kind of developers implementing and researching new processes, prototype research, environmental research purposes and for small pre-series or series.

Process Gases

The VSS-620 can be used with standard process gases, like Nitrogen, Oxygen, Forming Gas. The chamber is sealed and can easily be cleaned.

Gas flow control

One gas line with Mass Flow Controller (MFC) for Nitrogen (40 nlm = norm liter per minute) is default, three more gas lines (Option: MFC) are possible.

Vacuum

The system is vacuum capable of up to 10^{-3} hPa (optionally up to 10^{-6} hPa).

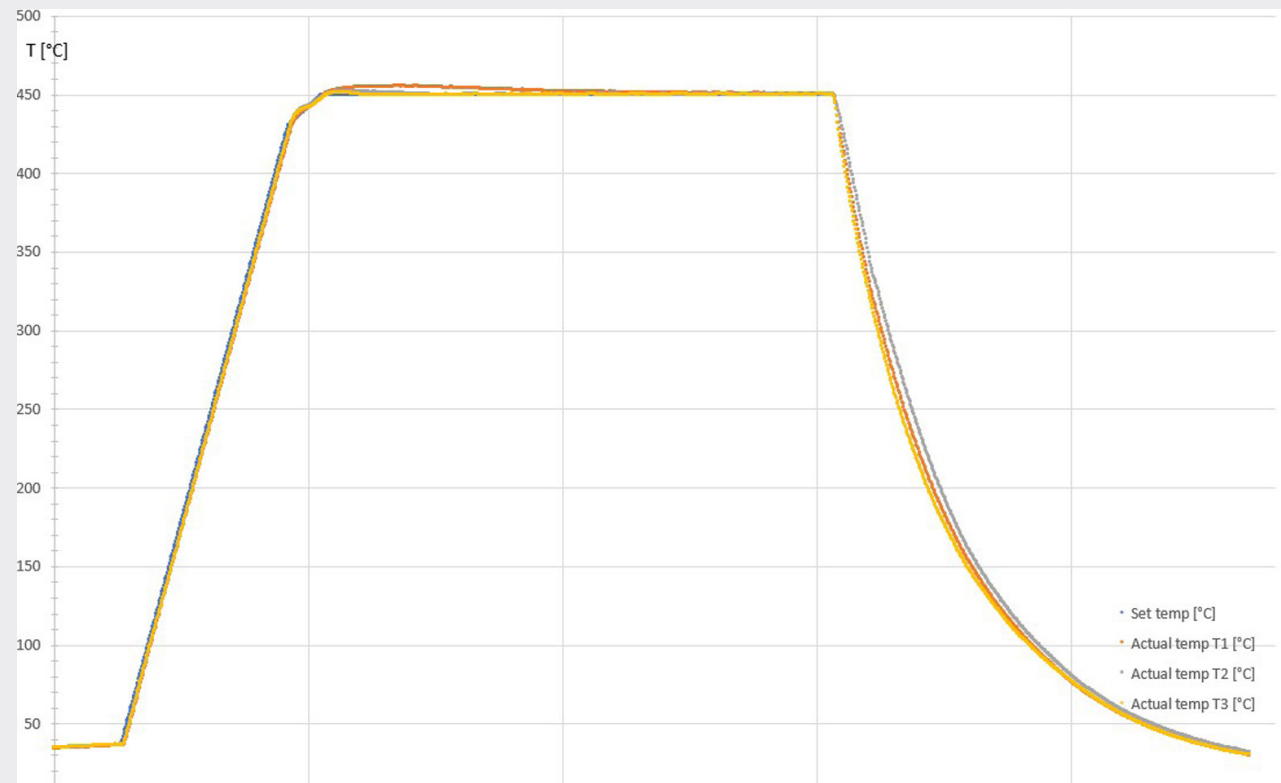
Heating

The maximal achievable temperature is 450 °C. Key features are precisely controlled fast ramp-up (xxx K/min) and excellent ramp-down rates up to xx K/min (depend on temperature and loading).

Temperature distribution

The VSS-620 allows an excellent temperature distribution and homogeneity ($\leq 1\%$).

VSS-620 Example for a standard temperature profile with



Programming

The VSS-620 is controlled by SPS SIMATIC® controller. A 12" touch panel allows a very comfortable programming and control of the process. There can be saved up to 50 programs with 50 steps each (unlimited programs can be down- and uploaded from an external data storage).

Process control

The software allows the permanent monitoring, readout and analysis of

- temperature
- process gas flow
- cooling water level status
- pressure value and status

Cooling process

The hot plate is active cooled with homogenous cooling from both sides.

The system does include an heat exchanger with 130 l tank volume.

Others

An interlock function is default.



VSS-650

Specification

Max. part size	620 mm x 620 mm
Chamber material	Aluminium chamber
Chamber size	650 mm x 650 mm x 75 mm
Chamber height	75 mm
Vacuum capability	Up to 10 ⁻³ hPa (optional up to 10 ⁻⁶ hPa)
Temperature max.	450 °C
Temp. uniformity	≤ 1 %
Heating	Bottom Heating: Infrared lamps cross aligned (67 kW)
Ramp up rate	XXX K/min
Ramp down rate	T = 450 °C > xxx °C: xxx K/min, T = 200 °C > 100 °C: xx K/min
Flow Controller	One Mass Flow Controller for 40 nlm (=norm liter per minute) as default, up to 3 more Mass Flow Controllers are available as option
Controller	SIMATIC® controller 50 programs with 50 steps each
Chamber cooling	By water cooling system
Substrate Cooling	By water cooling

Technical Data

Dimension oven	900 mm x 900 mm x 1345 mm (L x W x H)
Weight	480 kg
Electrical connection	3 x 230 V (Y) or 3 x 200 V (Y) or 3 x 208 V (Y) 67 kW

No. Options:

Additional process gas lines (example gases are to be determind):		
1	VSS-MFC-Ar	Additional process gas line for Argon (Ar) gas controlled by Mass Flow Controller
2	VSS-MFC-O2	Additional process gas line for Oxygen (O ₂) gas controlled by Mass Flow Controller
3	VSS-MFC-FG	Additional process gas line for Forming Gas (max. 10 % H ₂ /N ₂) gas controlled by Mass Flow Controller
Formic acid module and trap:		
4	FA II	Upgrade with integrated formic acid module with individually controlled process gas line
5	FA III	Upgrade with integrated formic acid module (process gas line shared with base VSS system)
6	FA IV	Formic acid mudule with separate gas line and automatic refilling
7	FA-T	Trap for formic acid vapors
8	FA-T-2	Double Trap for formic acid
Flux options:		
9	VSS-FluxHeat	Heated cover for sue with flux for avoiding condensating flux
10	VSS-FT	Flux trap
11	VSS-FT-2	Flux trap
Height and lift pins options:		
12	VSS-EH	Extended chamber height : On request
Hydrogen gas options		
14	H2	Hydrogen option for use of pure hydrogen gas (100 % H ₂)
15	H2S	Safety hood
Additional thermocouples:		
16	TC I	Upgrade with additional (flexible) thermocouple (not connected to process control, for external data logging)
17	TC II	Additional thermocouple to measure on device (plugged in chamber); for external measurement tool (max. 4 pcs)
Vacuum options (not including vacuum pumps):		
18	VAC I	Vacuum basic up to 3 hPa incl. vacuum sensor and valve
19	VAC II	Vacuum comfort up to 10 ⁻³ hPa incl. vacuum sensor and valve
Interfaces:		
20	VSS-RC	Remote control of top cover opening and closing, including connection to safety of external cabinet
21	VSS-SI	Serial interface between VSS system and external PC using USB 2.0 port and through USB 2.0 cable
Measurement options:		
22	MM	Moisture measurement
23	Ox	Atmospheric oxygen analyser
Other options:		
25	PT	Upgrade with 3 colors pat light
27	VSS-HT	On request
Accessories (vacuum pumps, chiller):		
28	MP	Membrane/diaphragm pump (not chemically resistant)
29	MPC	Chemically resistant membrane/diaphragm pump
30	RVP	Rotary vane pump for vacuum up to 10exp. ⁻³ with oil filter
31	GP	Graphite heating plate 620 x 620 mm

